

ES_LPC2114/24/01

Errata sheet LPC2114/01, LPC2124/01

Rev. 3 — 1 October 2011

Errata sheet

Document information

Info	Content
Keywords	LPC2114/01, LPC2124/01 errata
Abstract	<p>This errata sheet describes both the known functional problems and any deviations from the electrical specifications known at the release date of this document.</p> <p>Each deviation is assigned a number and its history is tracked in a table.</p>



Revision history

Rev	Date	Description
3	20111001	<ul style="list-style-type: none">Added Rev. D.
2	20110401	<ul style="list-style-type: none">The format of this errata sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.Added ADC.1 and Note.1.Combined errata for LPC2114/24/01 into one document.
1	20070727	<ul style="list-style-type: none">First version.

Contact information

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1. Product identification

The LPC2114/24/01 devices typically have the following top-side marking:

```
LPC21xxxxxxx
/01
xxxxxxx
xxYYWW R
```

The last letter in the last line (field 'R') will identify the device revision. This Errata Sheet covers the following revisions of the LPC2114/24/01:

Table 1. Device revision table

Revision identifier (R)	Revision description
'C'	First device revision
'D'	Second device revision

Field 'YY' states the year the device was manufactured. Field 'WW' states the week the device was manufactured during that year.

2. Errata overview

Table 2. Functional problems table

Functional problems	Short description	Revision identifier	Detailed description
CORE.1	Incorrect update of the Abort Link register in Thumb state	'C', 'D'	Section 3.1
ADC.1	External sync inputs not operational	'C', 'D'	Section 3.2

Table 3. AC/DC deviations table

AC/DC deviations	Short description	Revision identifier	Detailed description
n/a	n/a	n/a	n/a

Table 4. Errata notes table

Errata notes	Short description	Revision identifier	Detailed description
Note.1	Pin n.c. (pin 10) must not be driven LOW during reset.	'C', 'D'	Section 5.1

3. Functional problems detail

3.1 CORE.1: Incorrect update of the Abort Link register in Thumb state

Introduction:

If the processor is in Thumb state and executing the code sequence STR, STMIA or PUSH followed by a PC relative load, and the STR, STMIA or PUSH is aborted, the PC is saved to the abort link register.

Problem:

In this situation the PC is saved to the abort link register in word resolution, instead of half-word resolution.

Conditions:

The processor must be in Thumb state, and the following sequence must occur:

```
<any instruction>  
<STR, STMIA, PUSH> <---- data abort on this instruction  
LDR rn, [pc,#offset]
```

In this case the PC is saved to the link register R14_abt in only word resolution, not half-word resolution. The effect is that the link register holds an address that could be #2 less than it should be, so any abort handler could return to one instruction earlier than intended.

Work-around:

In a system that does not use Thumb state, there will be no problem.

In a system that uses Thumb state but does not use data aborts, or does not try to use data aborts in a recoverable manner, there will be no problem.

Otherwise the workaround is to ensure that a STR, STMIA or PUSH cannot precede a PC-relative load. One method for this is to add a NOP before any PC-relative load instruction. However this would have to be done manually.

3.2 ADC.1: External sync inputs not operational

Introduction:

In software-controlled mode (BURST bit is 0), the 10-bit ADC can start conversion by using the following options in the A/D Control Register:

26:24	START	When the BURST bit is 0, these bits control whether and when an ADC conversion is started:	0
000		No start (this value should be used when clearing PDN to 0).	
001		Start conversion now.	
010		Start conversion when the edge selected by bit 27 occurs on P0.16/EINT0/MAT0.2/CAP0.2 pin.	
011		Start conversion when the edge selected by bit 27 occurs on P0.22/CAP0.0/MAT0.0 pin.	
100		Start conversion when the edge selected by bit 27 occurs on MAT0.1.	
101		Start conversion when the edge selected by bit 27 occurs on MAT0.3.	
110		Start conversion when the edge selected by bit 27 occurs on MAT1.0.	
111		Start conversion when the edge selected by bit 27 occurs on MAT1.1.	

Fig 1. A/D control register options

Problem:

The external start conversion feature, ADCR:START = 0x2 or 0x3, may not work reliably and ADC external trigger edges on P0.16 or P0.22 may be missed. The occurrence of this problem is peripheral clock (pclk) dependent. The probability of error (missing a ADC trigger from GPIO) is estimated as follows:

- For PCLK_ADC = 60 MHz, probability error = 12 %
- For PCLK_ADC = 50 MHz, probability error = 6 %
- For PCLK_ADC = 12 MHz, probability error = 1.5 %

The probability of error is not affected by the frequency of ADC start conversion edges.

Work-around:

In software-controlled mode (BURST bit is 0), the START conversion options (bits 26:24 set to 0x1 or 0x4 or 0x5 or 0x6 or 0x7) can be used. The user can also start a conversion by connecting an external trigger signal to a capture input pin (CAPx) from a Timer peripheral to generate an interrupt. The timer interrupt routine can then start the ADC conversion by setting the START bits (26:24) to 0x1. The trigger can also be generated from a timer match register.

4. AC/DC deviations detail

4.1 n/a

5. Errata notes detail

5.1 Note.1

Pin n.c. (pin 10) must not be driven LOW during reset. If LOW on reset the device behavior is undetermined.

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7. Contents

1	Product identification	3
2	Errata overview	3
3	Functional problems detail	4
3.1	CORE.1: Incorrect update of the Abort Link register in Thumb state	4
	Introduction:	4
	Problem:	4
	Conditions:	4
	Work-around:	4
3.2	ADC.1: External sync inputs not operational ..	5
	Introduction:	5
	Problem:	5
	Work-around:	5
4	AC/DC deviations detail	6
4.1	n/a	6
5	Errata notes detail	6
5.1	Note.1	6
6	Legal information	7
6.1	Definitions	7
6.2	Disclaimers	7
6.3	Trademarks	7
7	Contents	8

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